# SMD CERAMIC ANTENNA Data Sheet

# CS-2450-16-A

For 2400-2500MHz

1.6x0.8x0.4mm [EIA1608]



#### **Feature**

- Light weight, compact
- Wide bandwidth, low cost
- Built-in antenna with high gain
- Operating Temp. : -40°C~+85°C

# **Application**

- Bluetooth
- WLAN 2.4
- WiFi 5/6/6E
- UWB



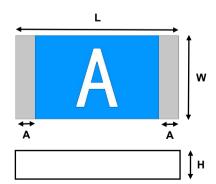
CS-2450-16-A

# **Electrical Characteristics per line(TA=25°C)**

Parameter	Specification	Units
Frequency Band	2400~2500	MHz
Polarization	Linear	
*Peak Gain	2.78	dBi
*Peak Efficiency	80.25	%
Impendance	50	Ω

Test condition: Test board size 70\*60 mm; Matching circuit: Pi matching circuit will be required.

#### **Product Dimension**



Units:mm

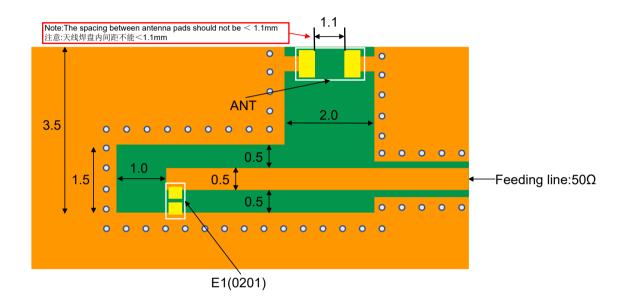
L	W	Н	Α	
1.60±0.20	0.80±0.20	0.40±0.10	0.2±0.07	



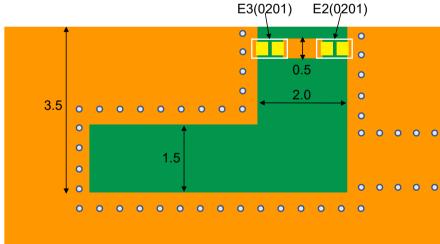
#### **Recommend PCB Layout1**

Test condition: Test board size 70\*60 mm;

#### Top Layer (unit mm)





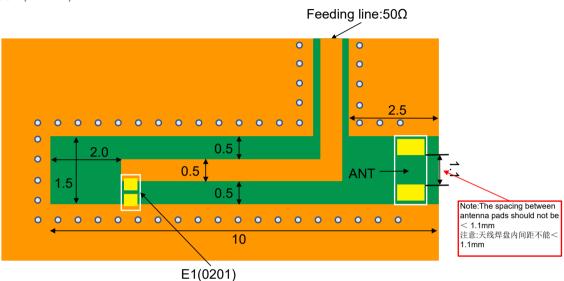




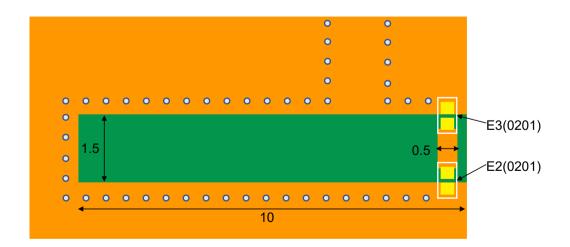
#### **Recommend PCB Layout2**

Test condition: Test board size 70\*60 mm;





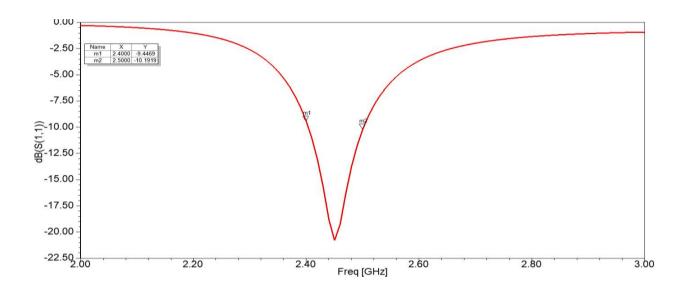
#### Bottom Layer (unit mm)





# **Typical Characteristics**

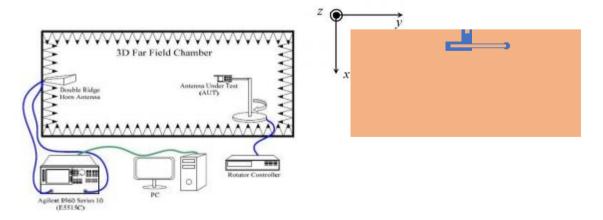
Fig. 1 Return Loss



#### **Radiation Pattern**

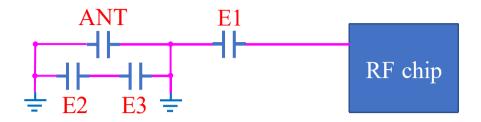
The Gain pattern is measured in FAR -field chamber. DUT is placed on the table of rotator, a standard horn antenna and Vector Network Analyzer is used to collect data.

Fig.2 FAR-field Chamber

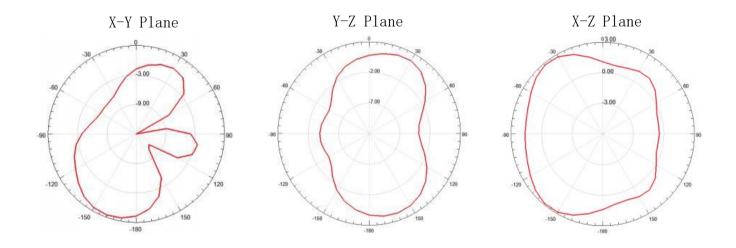




# **Equivalent circuit:**



#### **2D Gain Pattern**



# **Radiation Performance:**

Frequency	2400MHz	2450MHz	2500MHz	
Avg. gain	-1.92	-1.35	-1.56	
Peak gain 1.79		2.78	2.66	
Efficiency	74.55	80.25	76.98	



Item	Condition	Specification
Thermal shock	<ol> <li>30±3 minutes at -40°C±5°C,</li> <li>Convert to +105°C (5 minutes)</li> <li>30±3 minutes at +105°C±5°C,</li> <li>Convert to -40°C (5 minutes)</li> <li>Total 100 continuous cycles</li> </ol>	No apparent damage Fulfill the electrical spec. after test.
Humidity resistance	1. Humidity: 85% R.H. 2. Temperature: 85±5°C 3. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
High temperature resistance	No apparent damage Fulfill the electrical spec. after test.	1. Temperature: 150°C±5°C 2. Time: 1000 hours.
Low temperature resistance	1. Temperature: -40 ° C±5 ° C 2. Time: 1000 hours.	No apparent damage Fulfill the electrical spec. after test.
Soldering heat resistance	<ol> <li>Solder bath temperature : 260±5°C</li> <li>Bathing time: 10±1 seconds</li> </ol>	No apparent damage
Solderability	The dipped surface of the terminal shall be at least 95% covered with solder after dipped in solder bath of 245±5°C for 3±1 seconds.	No apparent damage

#### (2) Storage Condition

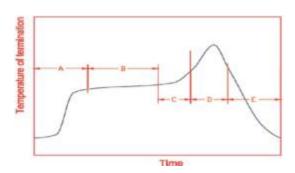
(a)At warehouse: The temperature should be within  $0 \sim 30^{\circ}$ C and humidity should be less than 60% RH.The product should be used within 1 year from the time of elivery.

(b)On board: The temperature should be within  $-40 \sim 85 \,^{\circ}$ C and humidity should be less than 85% RH.

# (3) Operating Temperature Range

Operating temperature range : -40  $^{\circ}\text{C}$  to +85  $^{\circ}\text{C}$  .

## **Recommended Reflow Solder curve**



A	1 <sup>st</sup> rising temperature	The normal to Preheating temperature	30s to 60s
В	Preheating	140°C to 160°C	60s to 120s
С	2 <sup>rd</sup> rising temperature	Preheating to 200°C	20s to 40s
D Main heati		# 220℃	50s~60s
		if 230°€	40s~50s
	Main heating	# 240°C	30s~40s
		# 250℃	20s~40s
		if 260℃	20s~40s
E	Regular cooling	200℃ to 100℃	1°C/s ~ 4°C/s



#### (1) Soldering Gun Procedure

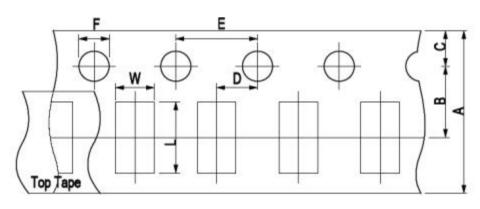
Note the follows, in case of using solder gun for replacement.

- (a) The tip temperature must be less than 350°C for the period within 3 seconds by using soldering gun under 30 W.
- (b) The soldering gun tip shall not touch this product directly.

#### (2) Soldering Volume

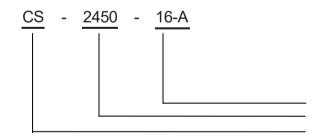
Note that excess of soldering volume will easily get crack the body of this product.

# **Package Information**



Α	В	С	D	Е	F	L	W
8.00±0.3	3.50± 0.05	1.75±0.1	2.00±0.05	4.00±0.1	1.50±0.1	2.30± 0.1	1.55± 0.1

# **Part Number System**



External Dimensions L\*W (mm) 1.6\*0.8 Central Frequency 2450 MHz Product Series: Chip Antenna

# **Marking**





#### 订货信息Order Information

Device	Package	Net Weight	Carrier	Quantity	HSF Status
CS-2450-16-A	1608	0.002g	Tape&Reel	5000pcs	RoHS compliant

# **Revision history**

Date	Revision	Description of changes
2023-01-03	1.0	First Version
2023-11-15	1.1	Add PCB Layout

The contents of this data sheet are subject to change without notice.

Please confirm the specifications and delivery conditions when placing your order.

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